# NOTES (UNLESS OTHERWISE SPECIFIED):

#### GENERAL

- 1) PCB IS x-LAYER, .062" THICK.
- CONSTRUCTION IS SOLDER-MASK-OVER-BARE-COPPER (SMOBC).
- 3) ACCEPTABILITY SHALL BE BASED ON IPC-A-600, CLASS 2.
- 4) THE FOLLOWING GERBER RS274X PHOTO TOOL FILES SHALL BE USED TO DEFINE ALL CIRCUIT FEATURES:

\*.GTL - TOP LAYER GERBER DATA

\*.G1 - MID LAYER 1 GERBER DATA

\*.GP1 - INTERNAL PLANE LAYER 1 GERBER DATA

\*.GP2 - INTERNAL PLANE LAYER 2 GERBER DATA \*.GP3- INTERNAL PLANE LAYER 3 GERBER DATA

\*.GP4 - INTERNAL PLANE LAYER 4 GERBER DATA

\*.GP5- INTERNAL PLANE LAYER 5 GERBER DATA \*.GBL - BOTTOM LAYER GERBER DATA

\*.GTO - TOP OVERLAY GERBER DATA

\*GTS - TOP SOLDER MASK GERBER DATA

\*.GTP - TOP-SIDE SOLDER PASTE MASK

\*GBO - BOTTOM OVERLAY GERBER DATA

\*GBS - BOTTOM SOLDER MASK GERBER DATA \*.GBP - BOTTOM-SIDE SOLDER PASTE MASK

5) THE PHOTO TOOL SHALL NOT BE COMPENSATED WITHOUT PRIOR ENGINEERING APPROVAL. PCB DESIGNER: RICH LOBDILL PH (805) 880-1621 FAX (805) 961-1792.

#### FABRICATION TOLERANCES

- 6) END PRODUCT CONDUCTOR WIDTHS AND PAD DIAMETERS SHALL NOT VARY MORE THAN 0.002" FROM THE 1:1 DIMENSIONS OF THE MASTER ARTWORK.

  7) THE CONDUCTIVE PATTERN SHALL BE POSITIONED SO THAT THE LOCATION OF ANY PAD OR
- LAND SHALL BE WITHIN 0.005" DIAMETER TO THE TRUE POSITION OF THE HOLE IT CRCUMSCRIBES.
- 8) ALL DRILL HOLE SIZES AND TOLERANCES APPLY AFTER PLATING.
- 9) THE MINIMUM ANNULAR RING SHALL BE 0.005".
- 10) BOW AND TWIST SHALL NOT EXCEED 0.010" PER INCH.
- 11) FOR PCB ROUTING DIMENSIONS: .XXX = +/-.005" .XX = +/-.020"

#### MATERIAL

- 12) BASE MATERIAL IS FR4 EPOXY FIBERGLASS
- 13) SEE STACK-UP LEGEND FOR COPPER CLADDING CALL OUTS

## PLATING

- 14) ALL HOLES AND CONDUCTIVE SURFACES SHALL BE PLATED WITH A MINIMUM OF 0.001" COPPER.
- 15) AFTER SOLDERMASK, ALL EXPOSED HOLES AND CONDUCTIVE SURFACES SHALL BE COATED WITH A GOLD IMMERSION PLATING TO PRESERVE SOLDERABILITY.

- 16) THE SOLDERMASK SHALL BE BLACK LIQUD PHOTO-IMAGEABLE PER IPC-SM-840, TYPE-B, CLASS 2. 17) THE SOLDERMASK REGISTRATION ALLOWANCE IS 0.003". THERE SHALL BE NO SOLDERMASK ON
- ANY SOLDER PAD OR LAND.
- 18) THE LEGEND SHALL BE SCREEN\_PRINTED LISING PERMANENT YELLOW EPOXY INK
- 19) THE SCREEN PRINTING REGISTRATION ALLOWANCE IS 0.007". THERE SHALL BE NO INK ON ANY SOLDER PAD OR LAND.
- 20) THE VENDOR CODE AND UL FLAMMABILITY RATING MAY BE ETCHED IN THE FOIL OR MARKED IN PERMANENT EPOXY NK (VENDOR'S OPTION).

### FLECTRICAL TESTING

21) ALL BOARDS SHALL BE ELECTRICALLY TESTED TO THE SUPPLIED IPC-D-356A NET LIST FOR CONTINUITY, OPENS AND SHORTS.

Layer Stack Up Detail for: 175-00024\_rev1, Backplane, Instrument Crate.PcbDoc COPPER THICKNESS 1/2 oz, 1 oz Finished Top Layer (\*.GTL) Mid-Layer 1 (\*.G1) 1 oz +24U (\*.GP1) 2 oz RTN (\*.GP2) 2 oz +3.3V (\*.GP3) 1 oz +12V (\*.GP4) 1 oz 1 oz Signal GND (\*.GP5) Bottom Layer (\*.GBL) 1/2 oz, 1 oz Finished

NOTE: 2 OZ COPPER FOR CERTAIN LAYERS

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# PRIMARY PCB SPECIFICATIONS

(REFER TO COMPLETE SPEC LISTING AT LEFT FOR FURTHER DETAILS)

NUMBER OF LAYERS 8 FINISHED THICKNESS .062"

SOLDER MASK COLOR -

NOTE: BOARD CUTOUTS (11 PLCS)-

BASE MATERIAL FR4 GOLD IMMERSION PLATING TYPE

**BLACK** 

Las Cumbres Observatory, Inc. 6740 Cortona Dr. Los Cumbres Observatory Global Telescope Network Goleta, CA 93117 www.lcogt.net 1:1 6/2/2011 175-00024, BACKPLANE, INSTRUMENT CRATE 1 ° X — GPT

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